

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	257/728,678,680,688,730 and @pd>"20050304"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:16
L2	676	257/728,678,680,688,730.ccls. and @pd>"20050304"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:32
L3	814	257/728.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:34
L4	511	438/106,121.ccls. and @pd>"20050304"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:48
L5	410	housing same (IC (integrated adj circuit)) same lid	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:58
L6	6	(housing same (IC (integrated adj circuit)) same lid).clm.	US-PGPUB	OR	ON	2006/04/12 09:58
S1	245	257/728.ccls. and (cavity opening)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 13:10
S2	857	257/678.ccls. and (cavity opening)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/04 20:11
S3	309	257/680.ccls. and (cavity opening)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 10:41
S4	675	257/680,688,730.ccls. and (cavity opening)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 10:41

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S5	90	copper with (RF adj shield)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 12:41
S6	711	ablestik	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 13:06
S7	23	ablestik and (opening cavity) and microwave	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 13:06
S8	0	ablestik same lid same (copper cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/05 13:11
S9	73	ablestik same (copper cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/18 11:27
S10	72	(indium with (attach\$2 secure\$1)) same (IC chip (integrated adj circuit))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/18 11:44
S11	26	(indium with (attach\$2 secure\$1)) same (IC chip (integrated adj circuit)) and package	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 09:15
S12	2	(indium with (attach\$2 secure\$1)) same (IC chip (integrated adj circuit)) and microwave	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/18 11:45
S13	53	(indium with (attach\$2 secure\$1)) with (IC chip (integrated adj circuit) microwave)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/18 11:50

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